

**In the Specification**

Please replace the title with the following amended title.

Thin Profile Battery Bonding Method, Method of Conductively Interconnecting Electronic Components, Battery Powerable Apparatus, Radio Frequency Communication Device, and Electric Circuit

Please replace the paragraph, under the heading “Cross Reference To Related Application”, inserted at page 1 by the preliminary amendment filed on February 26, 2004, with the following amended paragraph.

This patent application is a continuation application of U.S. Patent Application Serial No. 09/989,960 filed on November 21, 2001, entitled “Thin Profile Battery Bonding Method, Method of Conductively Interconnecting Electronic Components, Battery Powerable Apparatus, Radio Frequency Communication Device, and Electric Circuit,” naming Rickie C. Lake as inventor, now U.S. Patent No. 6,885,089, which is a divisional application of U.S. Patent Application Serial No. 09/480,076 filed on January 10, 2000, now U.S. Patent No. 6,881,294, which is a divisional application of U.S. Application Serial No. 09/022,812, filed February 12, 1998, now U.S. Patent No. 6,030,423, the disclosures of which are incorporated herein by reference.

Please replace the paragraph, from page 9, line 13 to page 10, line 12, with the following amended paragraph.

An exemplary single integrated circuit chip is described in U.S. Patent Application Serial No. 08/705,043, which names James O’Toole, John R. Tuttle, Mark E. Tuttle, Tyler Lowery, Kevin Devereaux, George Pax, Brian Higgins, Shu-Sun Yu, David Ovard, and Robert Rotzoll as inventors, which was filed on August 29, 1996 and now U.S. Patent No. 6,130,602, and is assigned to the assignee of this patent application. The entire assembly 50 preferably is encapsulated in and comprises an insulative epoxy encapsulant material. Example constructions and methods for providing the same are described in a) U.S. Patent Application entitled “Battery Mounting Apparatuses, Electronic Devices, And Methods Of Forming Electrical Connections”, which names Ross S. Dando, Rickie C. Lake, and Krishna Kumar as inventors, and was filed on February 19, 1998 and assigned U.S. Patent Application Serial No. 09/026,250, now U.S. Patent No. 5,978,230, and b) U.S. Patent Application entitled “Battery Mounting And Testing Apparatuses, Methods Of

Forming Battery Mounting And Testing Apparatuses, Battery-Powered Test-Configured Electronic Devices, And Methods Of Forming Battery-Powered Test-Configured Electronic Devices”, which names Scott T. Trosper as inventor, and which was filed on February 19, 1998 and assigned U.S. Patent Application Serial No. 09/026,247, now U.S. Patent No. 6,025,087, both of which are assigned to the assignee of this patent application. Each of the above three referenced patent applications is fully incorporated herein by reference. Although this disclosure shows a single battery 10 mounted to substrate 22 for clarity and ease of description, multiple button type batteries stacked in series are preferably utilized as is collectively disclosed in the incorporated disclosures.